



BUK9880-55A

N-channel TrenchMOS logic level FET

19 March 2014

Product data sheet

1. General description

Logic level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

2. Features and benefits

- Low conduction losses due to low on-state resistance
- Q101 compliant
- Suitable for logic level gate drive sources

3. Applications

- 12 V and 24 V loads
- Automotive and general purpose power switching
- Motors, lamps and solenoids

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 150 °C		-	-	55	V
I _D	drain current	V _{GS} = 5 V; T _{sp} = 25 °C; Fig. 3 ; Fig. 2		-	-	7	A
P _{tot}	total power dissipation	T _{sp} = 25 °C; Fig. 1		-	-	8	W
Static characteristics							
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 8 A; T _j = 25 °C		-	62	73	mΩ
		V _{GS} = 4.5 V; I _D = 8 A; T _j = 25 °C		-	-	89	mΩ
		V _{GS} = 5 V; I _D = 8 A; T _j = 25 °C; Fig. 13 ; Fig. 14		-	68	80	mΩ
Avalanche ruggedness							
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	I _D = 6 A; V _{sup} ≤ 55 V; R _{GS} = 50 Ω; V _{GS} = 5 V; T _{j(init)} = 25 °C; unclamped		-	-	36	mJ

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	 SC-73 (SOT223)	 mbb076
2	D	drain		
3	S	source		
4	D	drain		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BUK9880-55A	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223
BUK9880-55A/CU	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223

7. Marking

Table 4. Marking codes

Type number	Marking code
BUK9880-55A	988055A
BUK9880-55A/CU	988055

8. Limiting values

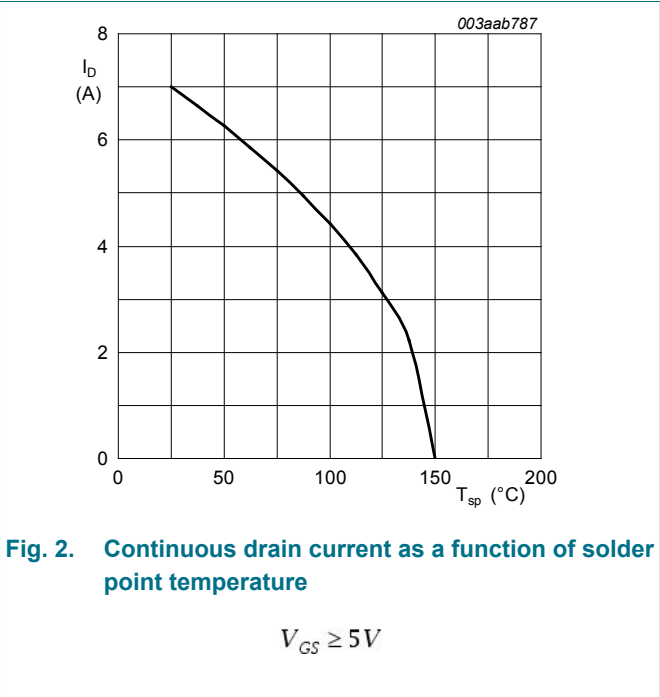
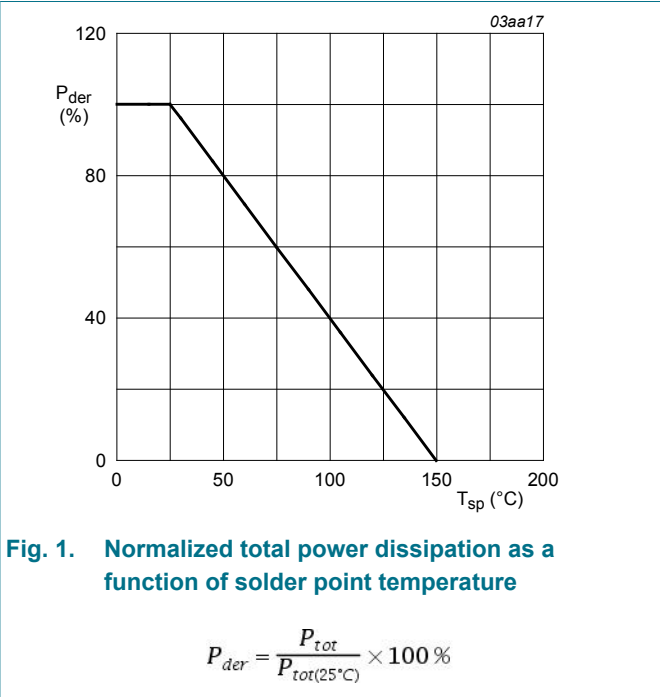
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage	$T_j \geq 25\text{ }^{\circ}\text{C}$; $T_j \leq 150\text{ }^{\circ}\text{C}$	-	55	V
V_{DGR}	drain-gate voltage	$R_{GS} = 20\text{ k}\Omega$	-	55	V
V_{GS}	gate-source voltage		-15	15	V
P_{tot}	total power dissipation	$T_{sp} = 25\text{ }^{\circ}\text{C}$; Fig. 1	-	8	W
I_D	drain current	$T_{sp} = 100\text{ }^{\circ}\text{C}$; $V_{GS} = 5\text{ V}$; Fig. 2	-	4	A
		$T_{sp} = 25\text{ }^{\circ}\text{C}$; $V_{GS} = 5\text{ V}$; Fig. 3 ; Fig. 2	-	7	A
I_{DM}	peak drain current	$T_{sp} = 25\text{ }^{\circ}\text{C}$; pulsed; $t_p \leq 10\text{ }\mu\text{s}$; Fig. 3	-	30	A

Symbol	Parameter	Conditions		Min	Max	Unit
T _{stg}	storage temperature			-55	150	°C
T _j	junction temperature			-55	150	°C
V _{GSM}	peak gate-source voltage	pulsed; t _p ≤ 50 μs		-15	15	V
Source-drain diode						
I _S	source current	T _{sp} = 25 °C		-	7	A
I _{SM}	peak source current	pulsed; t _p ≤ 10 μs; T _{sp} = 25 °C		-	30	A
Avalanche ruggedness						
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	I _D = 6 A; V _{sup} ≤ 55 V; R _{GS} = 50 Ω; V _{GS} = 5 V; T _{j(init)} = 25 °C; unclamped		-	36	mJ
E _{DS(AL)R}	repetitive drain-source avalanche energy	Fig. 4	[1][2][3][4]	-		J

- [1] Maximum value not quoted. Repetitive rating defined in avalanche rating figure.
- [2] Single-pulse avalanche rating limited by maximum junction temperature of 150 °C.
- [3] Repetitive avalanche rating limited by an average junction temperature of 145 °C.
- [4] Refer to application note AN10273 for further information.



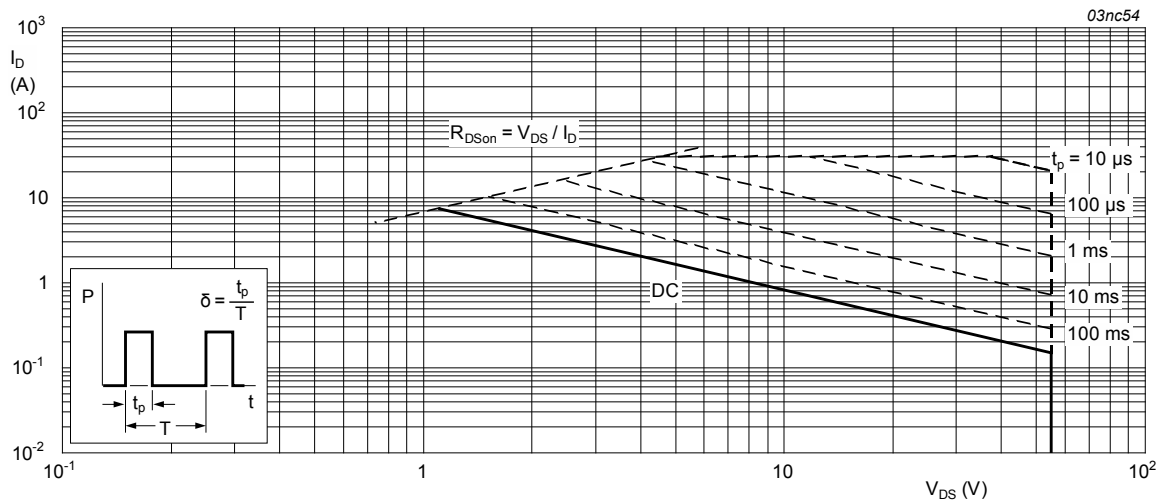


Fig. 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

$T_{amb} = 25^{\circ}C$; I_{DM} is single pulse

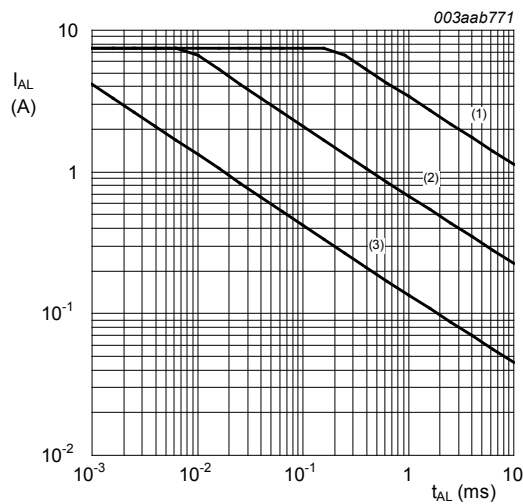


Fig. 4. Single-pulse and repetitive avalanche rating; avalanche current as a function of avalanche time.

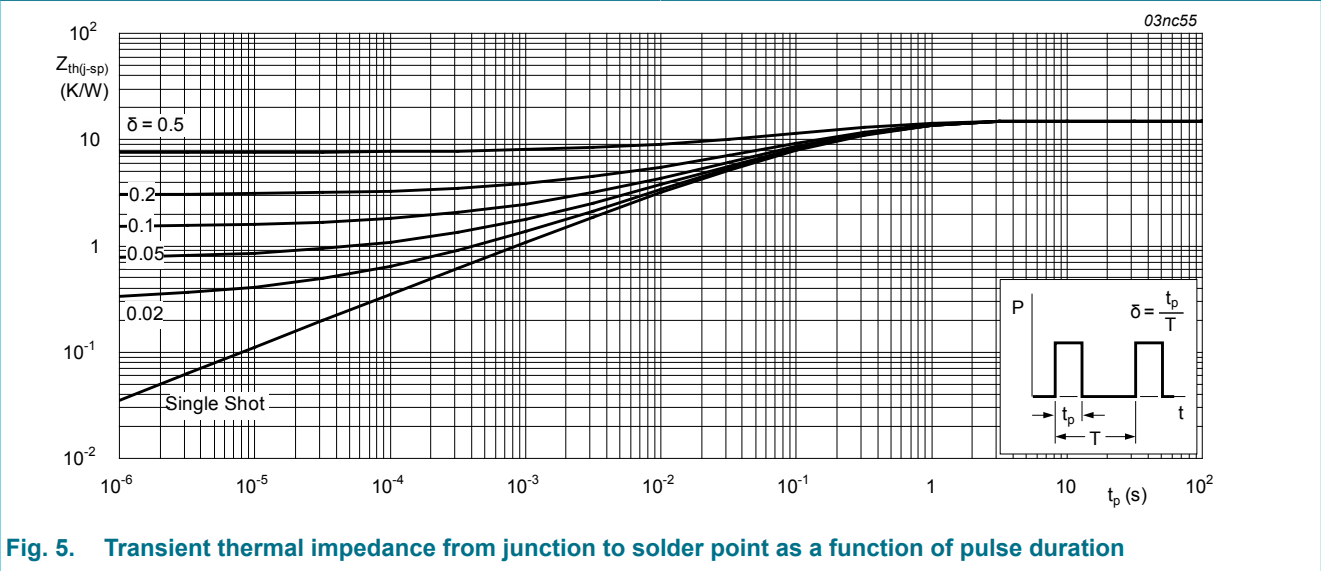
- (1) Single-pulse; $T_j = 25^{\circ}C$.
- (2) Single-pulse; $T_j = 125^{\circ}C$.
- (3) Repetitive.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	15	K/W

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	Fig. 5	-	120	-	K/W



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 0.25\text{ mA}; V_{GS} = 0\text{ V}; T_j = -55\text{ }^{\circ}\text{C}$	50	-	-	V
		$I_D = 0.25\text{ mA}; V_{GS} = 0\text{ V}; T_j = 25\text{ }^{\circ}\text{C}$	55	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1\text{ mA}; V_{DS} = V_{GS}; T_j = 25\text{ }^{\circ}\text{C};$ Fig. 12; Fig. 8	1	1.5	2	V
		$I_D = 1\text{ mA}; V_{DS} = V_{GS}; T_j = 150\text{ }^{\circ}\text{C};$ Fig. 12; Fig. 8	0.6	-	-	V
		$I_D = 1\text{ mA}; V_{DS} = V_{GS}; T_j = -55\text{ }^{\circ}\text{C};$ Fig. 12; Fig. 8	-	-	2.3	V
I_{DSS}	drain leakage current	$V_{DS} = 55\text{ V}; V_{GS} = 0\text{ V}; T_j = 150\text{ }^{\circ}\text{C}$	-	-	500	μA
		$V_{DS} = 55\text{ V}; V_{GS} = 0\text{ V}; T_j = 25\text{ }^{\circ}\text{C}$	-	0.05	10	μA
I_{GSS}	gate leakage current	$V_{GS} = 10\text{ V}; V_{DS} = 0\text{ V}; T_j = 25\text{ }^{\circ}\text{C}$	-	2	100	nA
		$V_{GS} = -10\text{ V}; V_{DS} = 0\text{ V}; T_j = 25\text{ }^{\circ}\text{C}$	-	2	100	nA
R_{DSon}	drain-source on-state resistance	$V_{GS} = 5\text{ V}; I_D = 8\text{ A}; T_j = 150\text{ }^{\circ}\text{C};$ Fig. 13; Fig. 14	-	-	147	m Ω
		$V_{GS} = 10\text{ V}; I_D = 8\text{ A}; T_j = 25\text{ }^{\circ}\text{C}$	-	62	73	m Ω
		$V_{GS} = 4.5\text{ V}; I_D = 8\text{ A}; T_j = 25\text{ }^{\circ}\text{C}$	-	-	89	m Ω

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
		$V_{GS} = 5\text{ V}$; $I_D = 8\text{ A}$; $T_j = 25\text{ }^{\circ}\text{C}$; Fig. 13 ; Fig. 14		-	68	80	mΩ
Dynamic characteristics							
$Q_{G(\text{tot})}$	total gate charge	$I_D = 10\text{ A}$; $V_{DS} = 44\text{ V}$; $V_{GS} = 5\text{ V}$; Fig. 11		-	11	-	nC
Q_{GS}	gate-source charge			-	1.6	-	nC
Q_{GD}	gate-drain charge	$I_D = 10\text{ A}$; $V_{DS} = 44\text{ V}$; $V_{GS} = 5\text{ V}$; Fig. 15		-	4.6	-	nC
C_{iss}	input capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 25\text{ V}$; $f = 1\text{ MHz}$; $T_j = 25\text{ }^{\circ}\text{C}$; Fig. 16		-	438	584	pF
C_{oss}	output capacitance			-	87	104	pF
C_{rss}	reverse transfer capacitance			-	62	85	pF
$t_{d(\text{on})}$	turn-on delay time	$V_{DS} = 30\text{ V}$; $R_L = 1.2\text{ }\Omega$; $V_{GS} = 5\text{ V}$; $R_{G(\text{ext})} = 10\text{ }\Omega$; $T_j = 25\text{ }^{\circ}\text{C}$		-	8	-	ns
t_r	rise time			-	118	-	ns
$t_{d(\text{off})}$	turn-off delay time			-	20	-	ns
t_f	fall time			-	32	-	ns
Source-drain diode							
V_{SD}	source-drain voltage	$I_S = 15\text{ A}$; $V_{GS} = 0\text{ V}$; $T_j = 25\text{ }^{\circ}\text{C}$; Fig. 17		-	0.85	1.2	V
t_{rr}	reverse recovery time	$I_S = 20\text{ A}$; $di_S/dt = -100\text{ A}/\mu\text{s}$; $V_{GS} = -10\text{ V}$; $V_{DS} = 30\text{ V}$; $T_j = 25\text{ }^{\circ}\text{C}$		-	33	-	ns
Q_r	recovered charge			-	60	-	nC

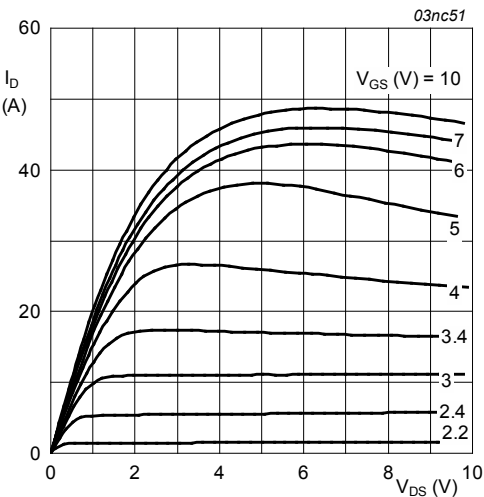


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

$T_j = 25\text{ }^{\circ}\text{C}$

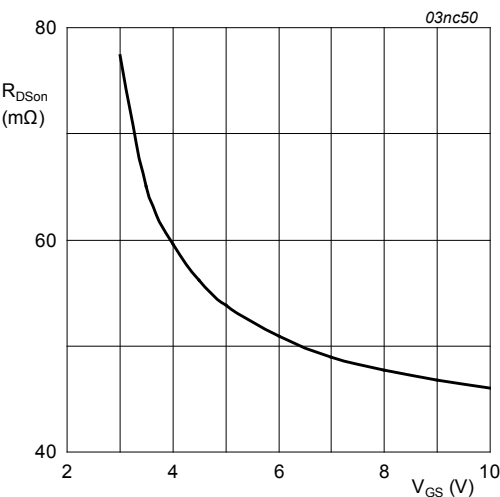
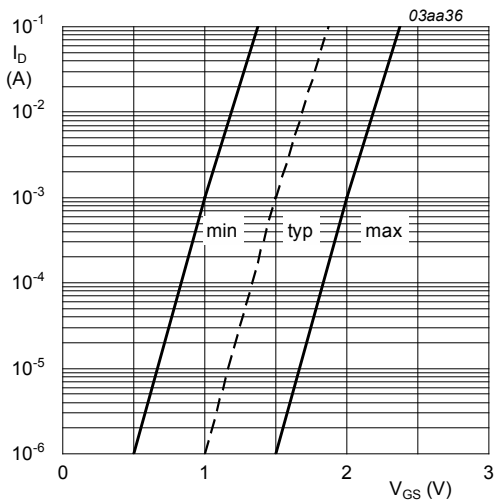


Fig. 7. Drain-source on-state resistance as a function of gate-source voltage; typical values

$T_j = 25\text{ }^{\circ}\text{C}$; $I_D = 10\text{ A}$



$T_J = 25\text{ }^{\circ}\text{C}; V_{DS} = 5\text{ V}$

Fig. 8. Sub-threshold drain current as a function of gate-source voltage

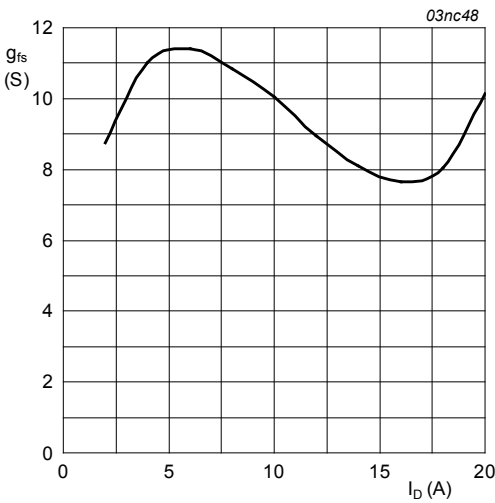


Fig. 9. Forward transconductance as a function of drain current; typical values

$T_J = 25\text{ }^{\circ}\text{C}; V_{DS} = 25\text{ V}$

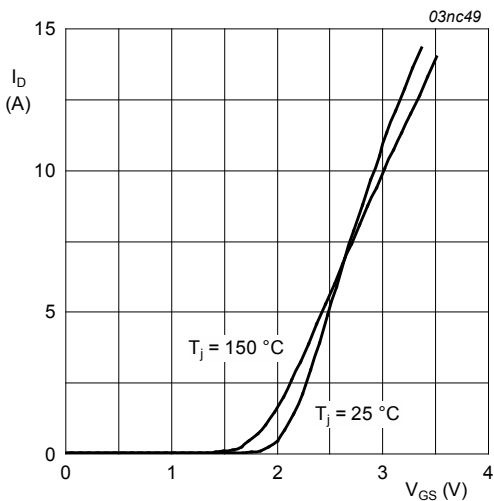


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

$V_{DS} = 25\text{ V}$

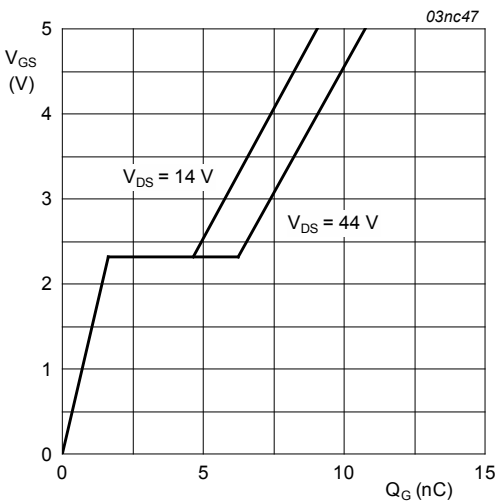


Fig. 11. Gate-source voltage as a function of turn-on gate charge; typical values

$T_J = 25\text{ }^{\circ}\text{C}; I_D = 10\text{ A}$

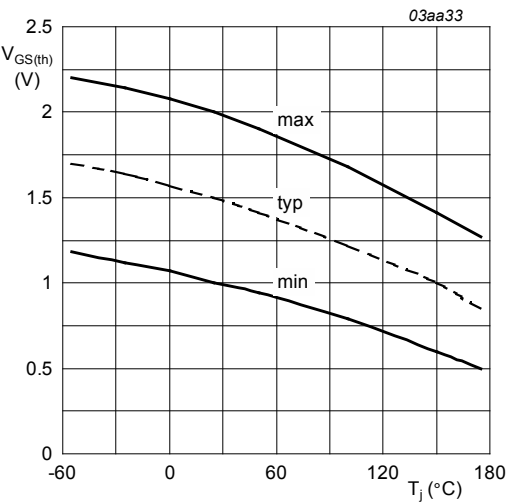


Fig. 12. Gate-source threshold voltage as a function of junction temperature

$$I_D = 1\text{ mA}; V_{DS} = V_{GS}$$

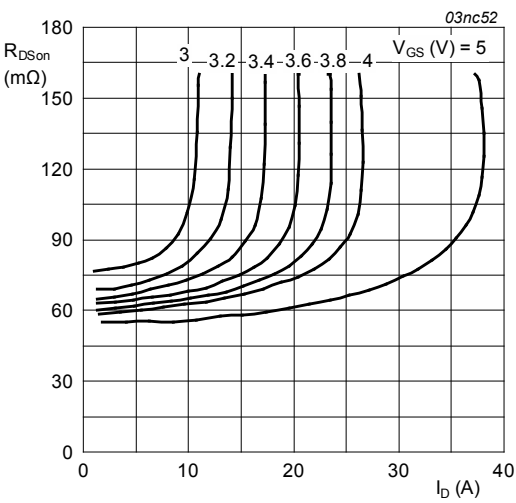


Fig. 13. Drain-source on-state resistance as a function of drain current; typical values

$$T_j = 25^\circ\text{C}$$

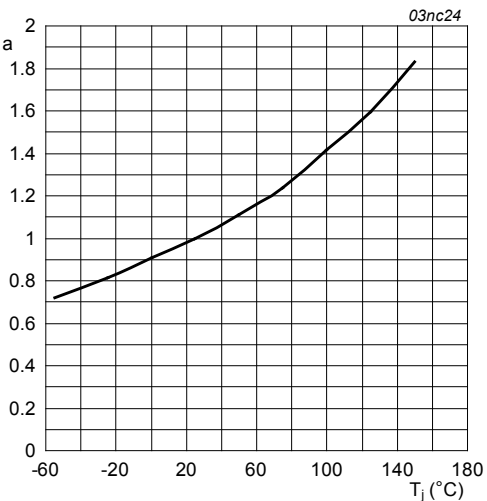


Fig. 14. Normalized drain source on-state resistance factor as a function of junction temperature

$$a = \frac{R_{DS(on)}}{R_{DS(on)25^\circ\text{C}}}$$

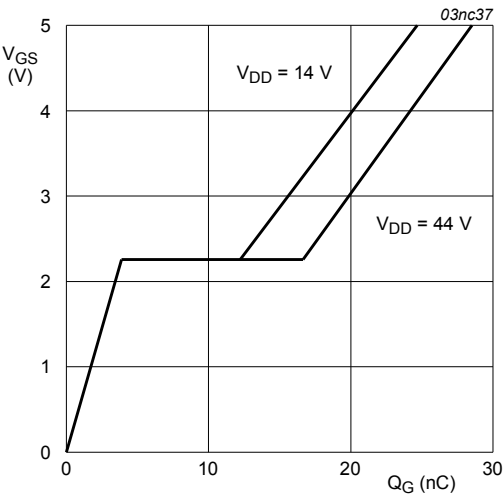
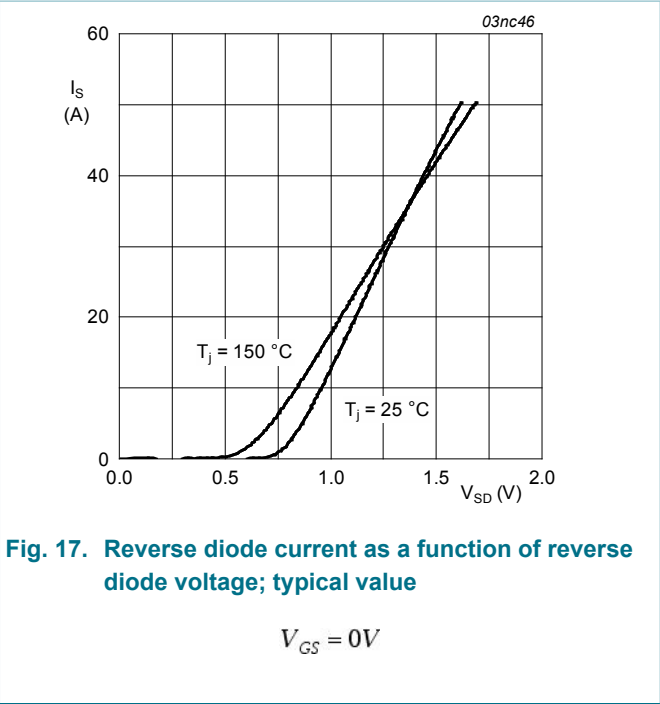
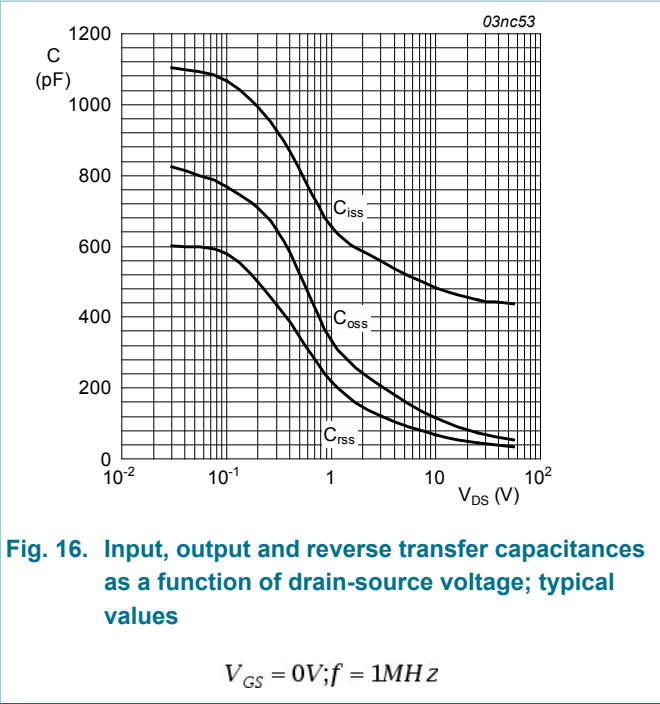


Fig. 15. Gate-source voltage as a function of turn-on gate charge; typical values

$$T_j = 25^\circ\text{C}; I_D = 15\text{ A}$$



11. Package outline

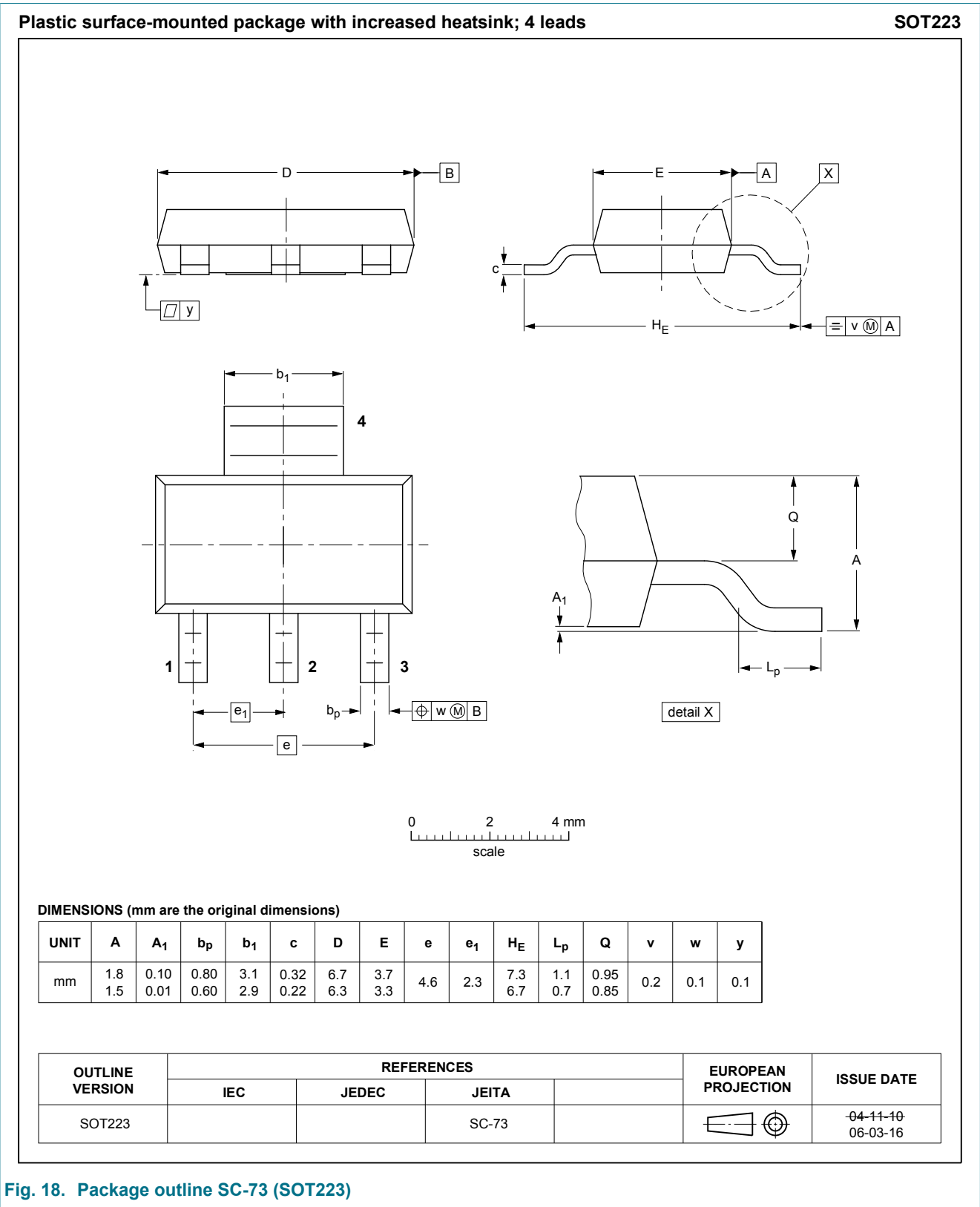


Fig. 18. Package outline SC-73 (SOT223)

12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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